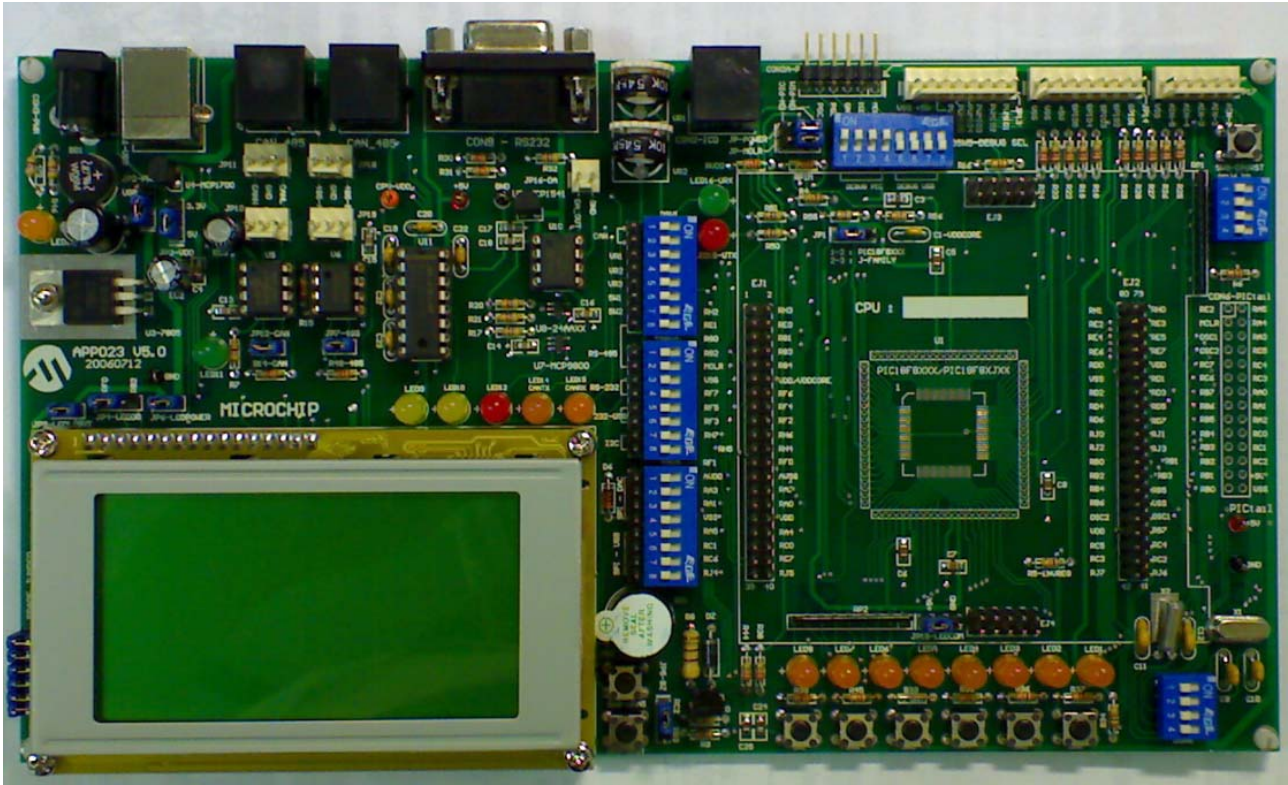


MICROCHIP EVM Board : APP023 使用手冊



1-1. APP023 多工能實驗板介紹：

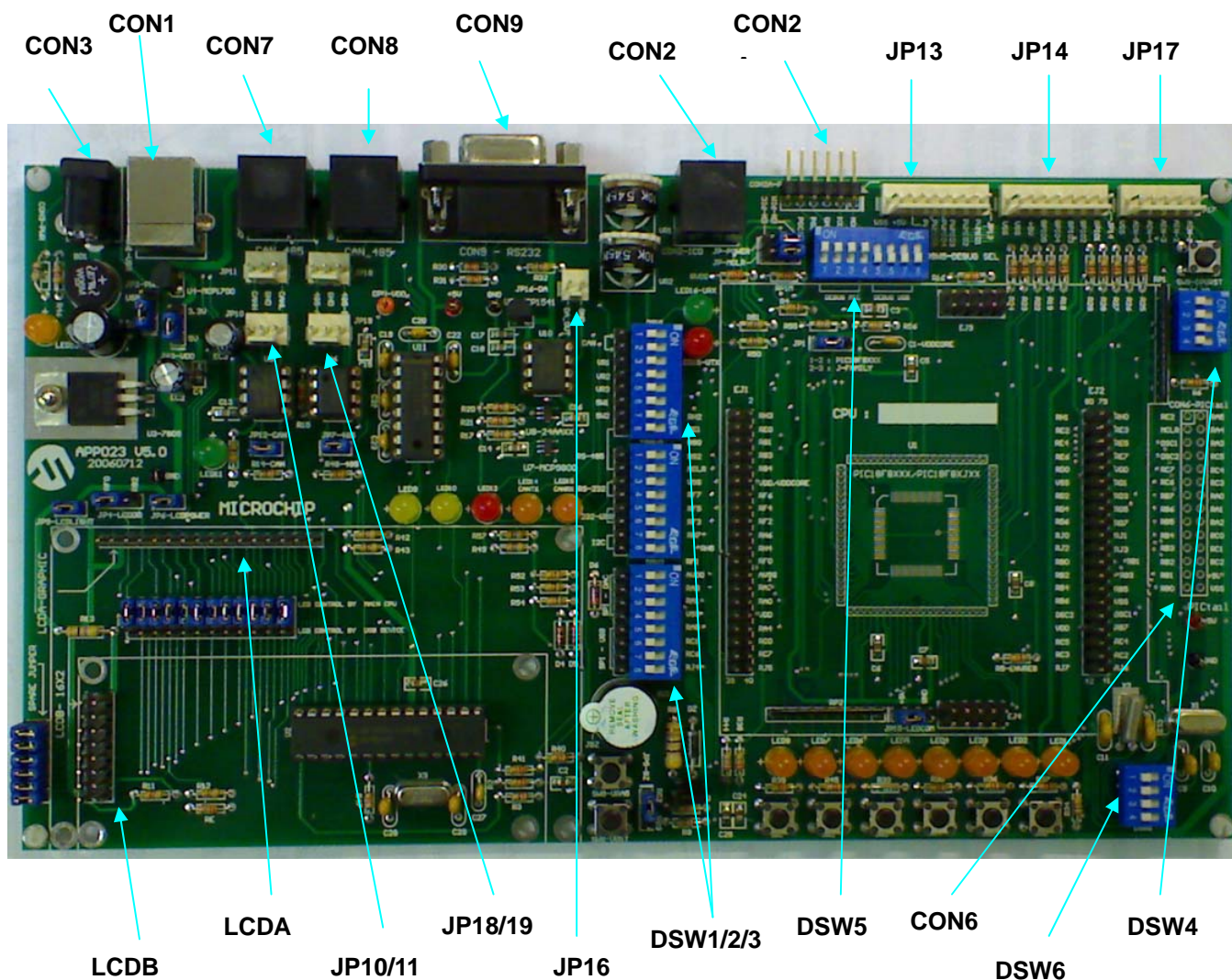
Microchip 在推出 PIC18 系列的 MCU 之後，更推出了一系列功能更多的微處理器，包括內含 CAN、USB、ETHERNET、LCD 等的微處理器。還有使用較先進製程而達到更高功能/價格比的 PIC18FJ 系列以及執行效能數倍於 PIC18F 系列的 16-Bit MCU - PIC24F/PIC24H 以及 dsPIC30F/dsPIC33F。爲了讓有心學習這些新型微處理器的使用者能有一個標準化的共同平台。於是 Microchip Taiwan office 推出 **APP023** 實習板，來滿足此類的需求。

APP023 的 CPU 可以是安裝於主機板上的 80 PIN PIC18FXXXX or pic18FXXJXX. 或者利用 EJ1 – EJ4 這 4 個連接器，接上另外設計的 PIM 模組並且調整 JP-POWER & JP-MCLR 就可以 DISABLE 主機板的 CPU，就可以外接其他的 CPU。目前已經完成的 PIM 如下：

- APP023-1： 用於 80-PIN 的 PIC18F 系列
- APP023-2： 用於 dsPIC33FJ128MC708 或相對應的 CPU
- APP023-3： 用於 dsPIC30F6010A 或相對應的 CPU

1-2. APP023 主要的 CONNECTOR 及其功能

以下為 APP023 主要 CONNECTOR 的位置標示

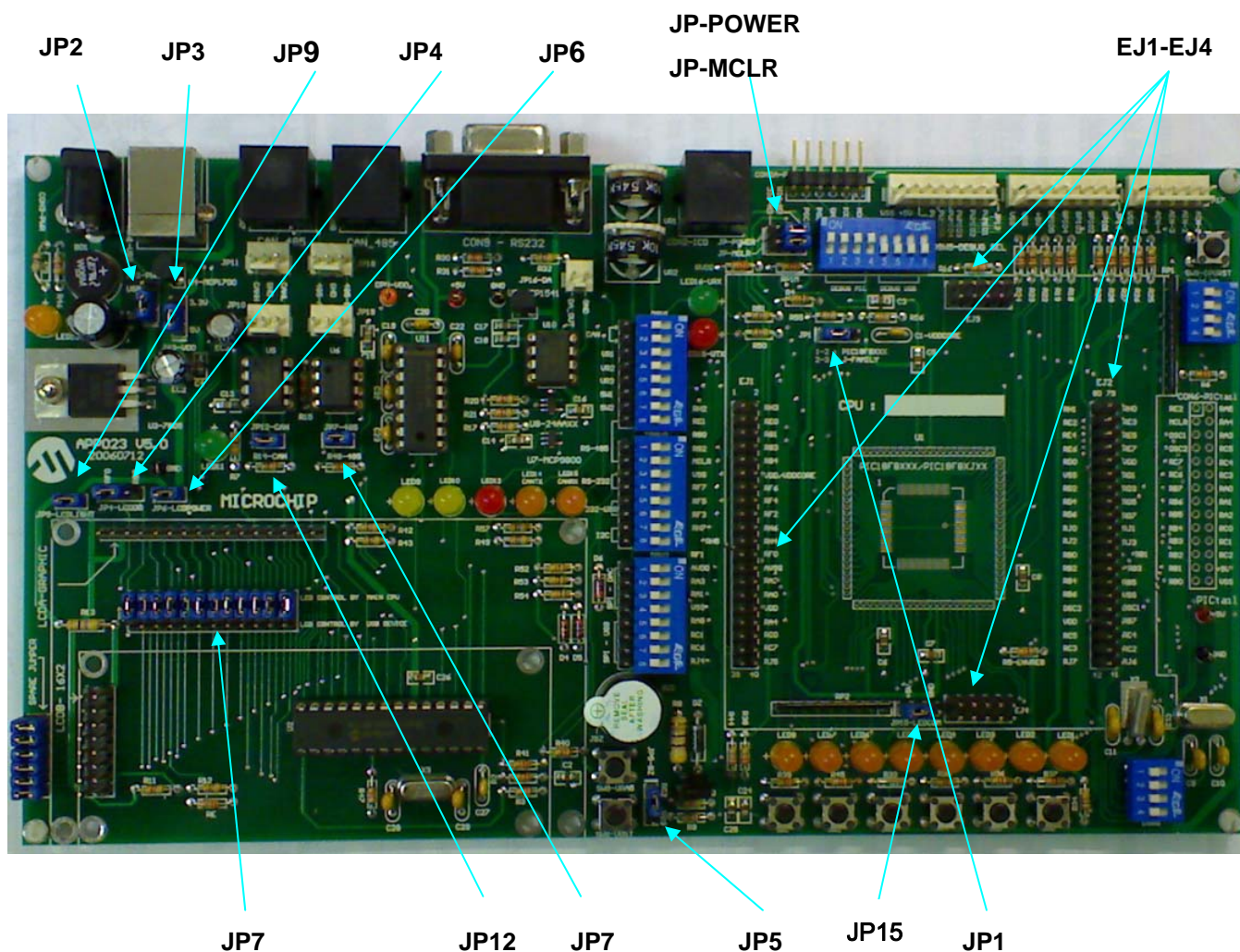


- CON1 USB 連接器 **
 (APP023 可由 USB Bus 供電，但需注意 USB 的供電是否足夠且須調整 JP2)
- CON2 ICD2 除錯及燒錄用連接器 **
- CON2A 與 PICKit2 相容的 ICD/ICSP 連接器 **
- CON3 2.1mm 9V DC 電源輸入
- CON6 與 PICTail 信號相容的界面，可接 Microchip 標準的 pictAIL 子卡
- CON7 CAN 與 RS-485 共用的連接器，與 CON8 是並連的
- CON8 CAN 與 RS-485 共用的連接器，與 CON7 是並連的
- CON9 DB-9，用於 RS-232 通信的 9-PIN D-Type Connector
- LCDA 使用於連接 Graphic LCD 模組的連接器
- LCDB 使用於連接 文字型 LCD 模組的連接器

DSW5	切換 CON2 及 CON2A 的 ICD/ICSP 信號連接至主 CPU 或 U2(PIC18F2550)	
DSW6	CPU 的主要外接振盪器與 TIMER1 振盪器的致能開關	
	CPU XTAL 致能 -> DSW6 的 1 & 2	
	TIMER1 XTAL 致能-> DSW6 的 3 & 4	
DSW4	保留來做為 ID 選擇的開關，有 RP1 排阻為提昇電阻並連接至 CPU 的下列信號	
	DSW4-PIN1	- 連接到 P-GPIO1/RH0
	DSW4-PIN2	- 連接到 P-GPIO2/RH1
	DSW4-PIN3	- 連接到 P-GPIO3/RH2
	DSW4-PIN4	- 連接到 P-GPIO4/RH3
DSW1~3	DSW1, DSW2, DSW3 用來切換 CPU 信號與機板上的周邊是否連線	
	DSW1-PIN1/2	CAN 收發器 (U5, MCP2551)
	DSW1-PIN3	VR1
	DSW1-PIN4	VR2
	DSW1-PIN5	VR3 (用來讀取 SW3 ~ SW6 的按鍵值)
	DSW1-PIN6	SW1 (連接到按鍵 1)
	DSW1-PIN7	SW2 (連接到按鍵 2)
	DSW1-PIN8	RS-485 DE (連接到 P-RS485DE/RB4)
	DSW2-PIN1/2	RS485 的 TX & RX, 接到 P-UTX/RC6 & P-URX/RC7
	DSW2-PIN3/4	RS-232 的 TX & RX, 接到 P-UTX/RC6 & P-URX/RC7
	DSW2-PIN5/6	利用 RS-232 與 USB (PIC18F2550) 的 RS-232 連接
		UTX-USB/URX-USB 與主 CPU 的 P-UTX/RC6, P-URX/RC7
	DSW2-PIN7/8	利用 I2C 連接機板上的溫度感測器與 EEPROM
	DSW3-PIN1/4	利用 SPI 連接機板上的 DAC (MCP4921)
	P-GPIO5/RB1	- LOAD-DA
	P-SPIDO/RC5	- SPIDO-DA
	P-SPISCK/RC3	- SPISCK-DA
	P-SPISS/RB5	- SPISS-DA
	DSW3-PIN5/8	利用主 CPU 的 SPI 與 USB (PIC18F2550) 的 SPI 相連
	P-SPIDI/RC4	- SPIDI/USB
	P-SPIDO/RC5	- SPIDO/USB
	P-SPISCK/RC3	- SPISCK/USB
	P-SPISS/RB5	- SPISS/USB

1-3. APP023 主要的 JUMPER 及其功能

以下為 APP023 主要 JUMPER 的位置標示



JP2 5V VCC 來源選擇，1&2 ON 選外部的 9V DC，2&3 ON 選 USB

JP3 主 CPU VDD 的電壓選擇，1&2 ON 選 5V，2&3 ON 選 3.3V

JP-POWER JP-POWER & JP-MCLR 控制 CPU 的 VDD 與 MCLR 要供應至主機板的 CPU 或 PIM

JP-MCLR >> JP-POWER & JP-MCLR 的 1&2 ON 時，VDD 與 MCLR 供應至主機板的 CPU

>> JP-POWER & JP-MCLR 的 2&3 ON 時，VDD 與 MCLR 供應至 PIM

** 利用 JP-POWER & JP-MCLR 的控制，可以讓使用者在 PIM 不拔除的狀態下自行選擇要讓主機板的 CPU 或 PIM 上的 CPU 工作

** PIM 是 Plug-In-Module 的縮寫，指的是 CPU 的擴充板

JP1 用來選擇主機板上的 CPU 種類

>> 1&2 ON 選擇 PIC18F8XXX 等可工作至 5V DC 的 CPU

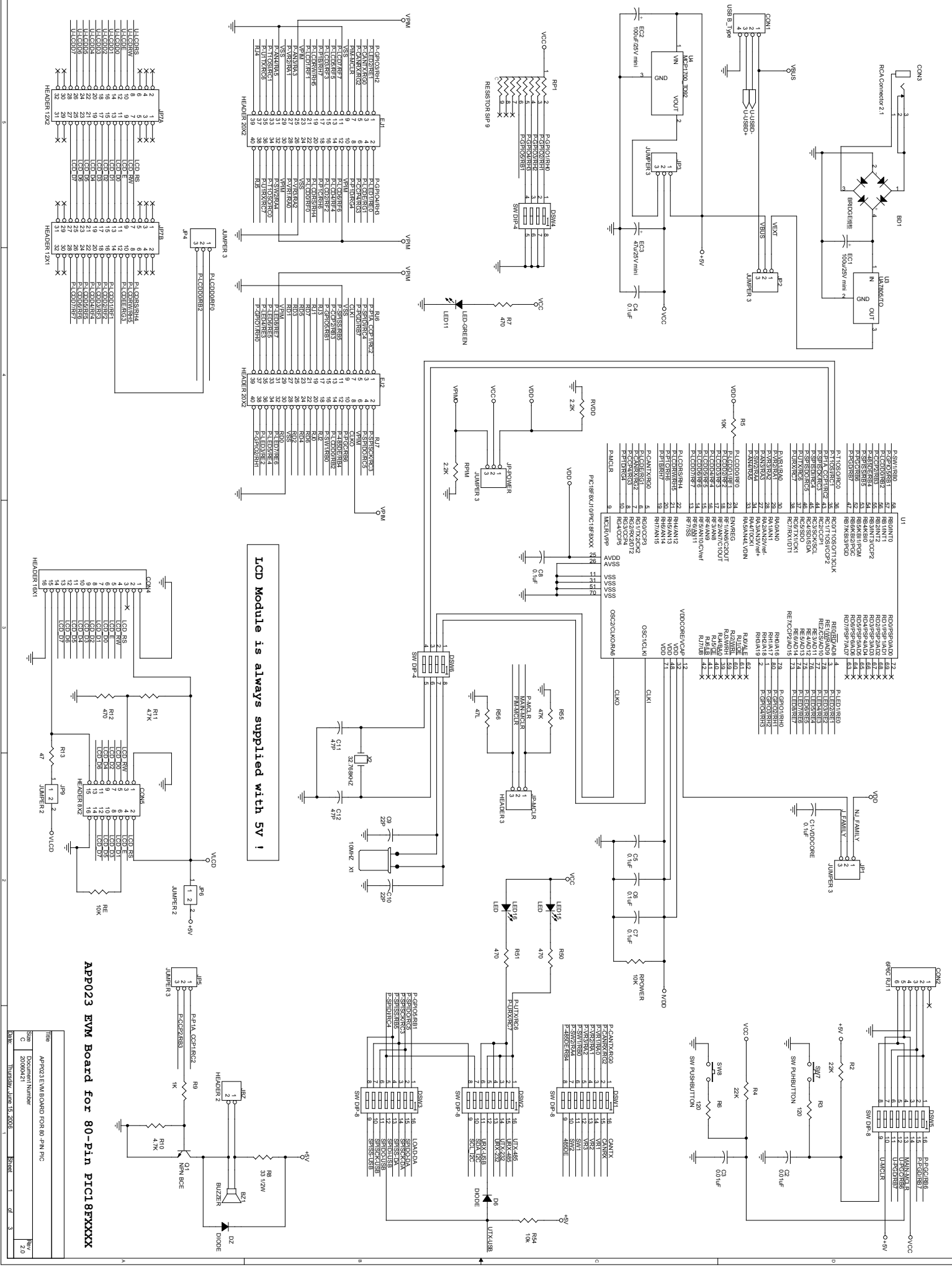
>> 2&3 ON 選擇工作電壓為 3.3 V 的 PIC18FXXJXX，J 系列產品

EJ1-EJ4 這 4 個 Connector 用來連接 PIM 或者是使用者自行設計的轉接板

JP15	控制 LED1 到 LED8 限流電阻要共地或者是 VDD APP023 在出貨時的接法為共 VDD 的方式
JP5	選擇蜂鳴器由 RC2 or RB3 推動
JP7	RS-485 終端電阻 (R48)的致能用
JP12	CAN 終端電阻 (R14) 的致能用
JP7	12*3 的 Jumper , 用來選擇 LCD 的驅動信號來自主 CPU 或是 USB 控制器(U2) APP023 的預設值為 2&3 ON , 也就是由主 CPU 來控制 LCD
JP9	控制 LCD 的背光電源 , CLOSE = ON
JP4	選擇 LCD 模組的 Data 0 來源 , 1&2 ON = RF0 , 2&3 ON = RB2
JP6	LCD 模組的電源開關

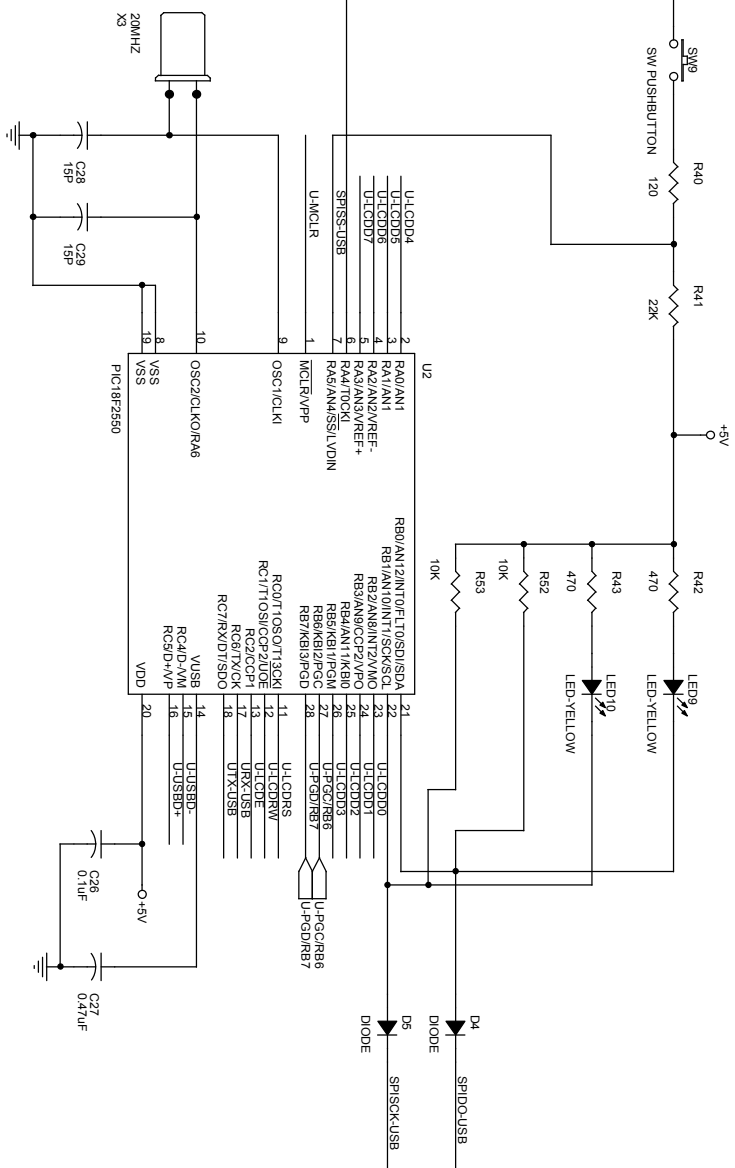
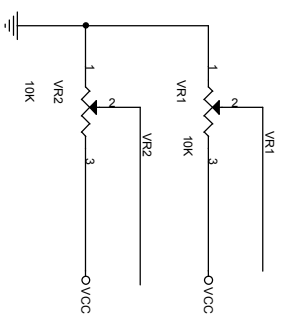
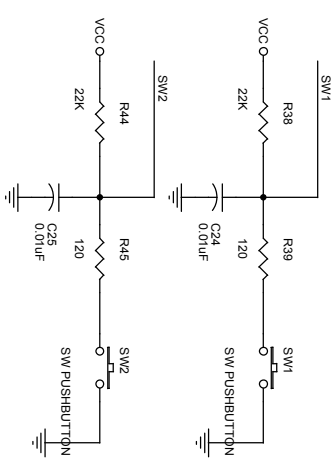
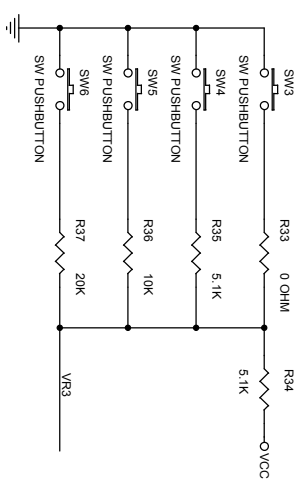
1-4 電路圖

以下為 APP023 之線路圖

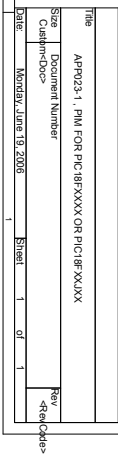


APP023 EVM Board for 80-Pin PIC18FXXXX

Rev	APP023 EVM BOARD FOR 80-PIN PIC
Desc	Board Number
C	20090421
Rev	2.0



Title				
<Title>				
Size B		Document Number		Rev
<Doc>				<Rev>
Date:	Thursday, June 15, 2006	Sheet	3	of 3
		C:\Program Files\Autodesk\AutoCAD 2006\acad.dwg		





**DOT MATRIX
LIQUID CRYSTAL DISPLAY
MODULE**

**LMG-SSC12K64 Serial
USER' MANUAL**

	LMG-SSC12K64DRG		LMG-SSC12K64DRY
	LMG-SSC12K64DLGY		LMG-SSC12K64DLYY
	LMG-SSC12K64DLGY-E		LMG-SSC12K64DLYY-E

PROPOSED BY		APPROVED
Design	Approved	

SDEC TECHNOLOGY CORP.

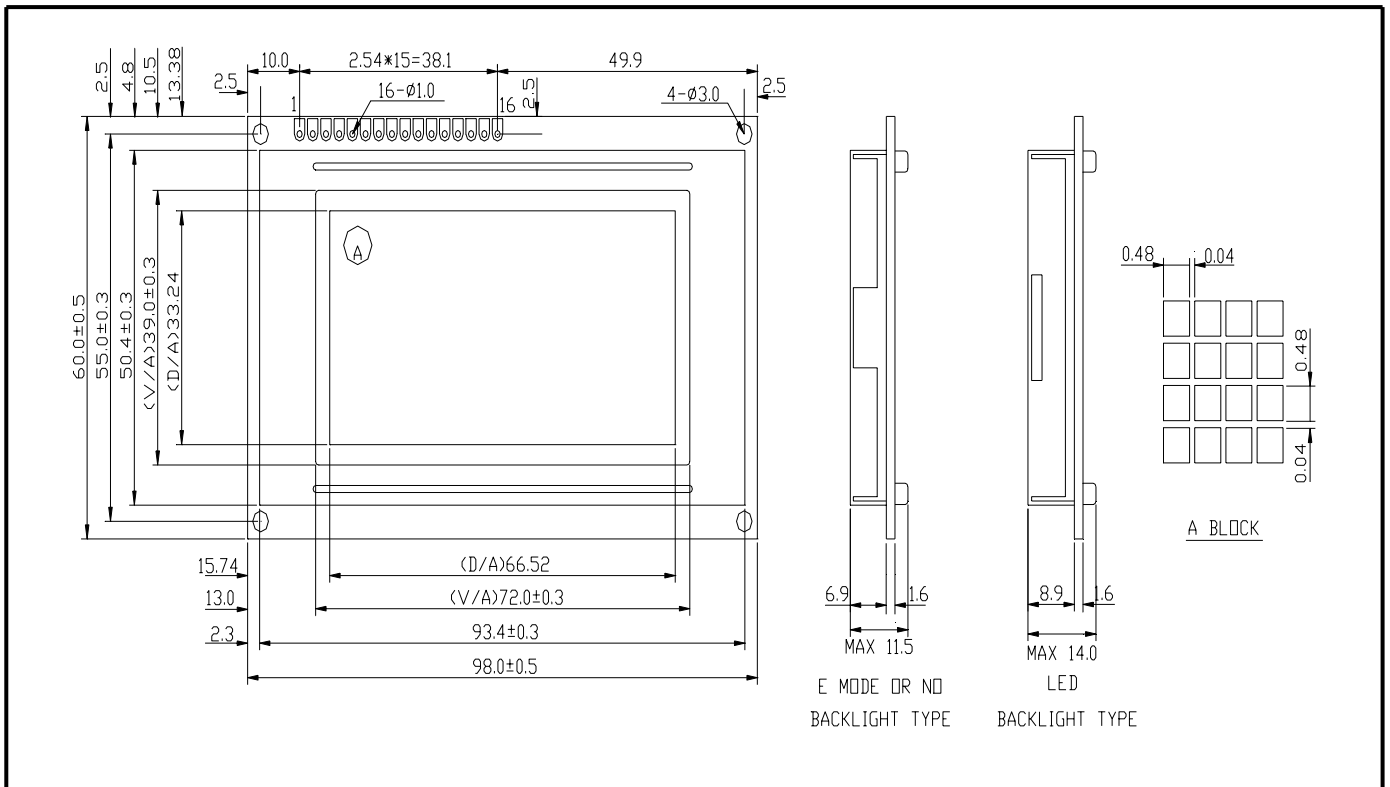
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1. Mechanical Specification

ITEM	STANDARD VALUE			UNIT
NUMBER OF CHARACTERS	8 CHARACTERS X 4 LINES (16*16 中文字)			--
CHARACTER FORMAT	16 X 16 DOTS			--
MODULE DIMENSION	98.0 (W) X 60.0 (H) X 11.5 (T)	98.0 (W) X 60.0 (H) X 14.0 (T)		mm
VIEWING DISPLAY AREA	72.0 (W) X 39.0 (H)			mm
ACTIVE DISPLAY AREA	66.52 (W) X 33.24 (H)			mm
DOT SIZE	0.48 (W) X 0.48 (H)			mm
DOT PITCH	0.52 (W) X 0.52 (H)			mm
LMG-SSC12K64DRG	STN , Gray , 1/32 Duty , 6 O'clock			
LMG-SSC12K64DRY	STN , Yellow Green , 1/32 Duty , 6 O'clock			
LMG-SSC12K64DLGY	STN , Gray , 1/32 Duty , 6 O'clock , LED Backlight			
LMG-SSC12K64DLYY	STN , Yellow Green , 1/32 Duty , 6 O'clock , LED Backlight			
LMG-SSC12K64DLGY-E	STN , Gray , 1/32 Duty , 6 O'clock , E Mode LED Backlight			
LMG-SSC12K64DLYY-E	STN , Yellow Green , 1/32 Duty , 6 O'clock , E Mode LED Backlight			
LED Backlight Color	Yellow Green			
LED Backlight Input	DC +5V	V	150	mA
Backlight Half-Lift Time	50,000			HR.
E Mode LED Backlight Color	Yellow Green			
E Mode LED Backlight Input	DC +5V	V	100	mA
E mode Backlight Half-Lift Time	30,000			HR.

2. Mechanical Diagram



3. Interface Pin Connections

NO	SYMBOL	LEVEL	FUNCTION	NO	SYMBOL	LEVEL	FUNCTION
1	VSS	--	GND (0V)	9	DB2	H/L	Data Bit 2
2	VDD	H/L	DC +5V	10	DB3	H/L	Data Bit 3
3	N.C	--	N.C	11	DB4	H/L	Data Bit 4
4	RS	H/L	Register select	12	DB5	H/L	Data Bit 5
5	R/W	H/L	Read/Write	13	DB6	H/L	Data Bit 6
6	E	H,H→L	Enable signal	14	DB7	H/L	Data Bit 7
7	DB0	H/L	Data Bit 0	15	A(+)	DC +5V	LED Backlight +
8	DB1	H/L	Data Bit 1	16	K(-)	0V	LED Backlight -

4. Absolute Maximum Ratings

ITEM	SYMBOL	MIN.	TYPE	MAX.	UNIT
OPERATING TEMPERATURE	TOP	0	--	+50	°C
STORAGE TEMPERATURE	TST	-10	--	+60	°C
INPUT VOLTAGE	VI	VSS	--	VDD	V
SUPPLY VOLTAGE FOR LOGIC	VDD-VSS	--	5.0	6.5	V
SUPPLY VOLTAGE FOR LCD	VDD-VO	--	--	6.5	V
STATIC ELECTRICITY	Be sure that you are grounded when handing LCM.				

5. Electrical Characteristics

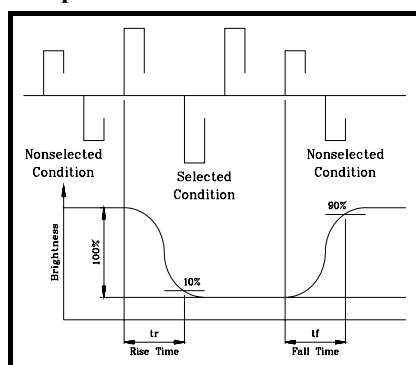
ITEM	SYN	CONDITION	MIN.	TYPE	MAX.	UNIT
SUPPLY VOLTAGE FOR LOGIC	VDD-VSS	--	4.5	5.0	5.5	V
SUPPLY VOLTAGE FOR LCD	VDD-VO	Ta= 0 °C	--	6.1	--	V
		Ta= +25 °C	--	5.8	--	V
		Ta= +50 °C	--	5.5	--	V
INPUT HIGH VOLTAGE	VIH	--	2.2	--	VDD	V
INPUT LOW VOLTAGE	VIL	--	0	--	0.6	V
OUTPUT HIGH VOLTAGE	VOH	--	2.4	--	--	V
OUTPUT LOW VOLTAGE	VOL	--	--	--	0.4	V
SUPPLY CURRENT	IDD	VDD=+5V	--	4.5	6.0	mA

6. Optical Characteristics

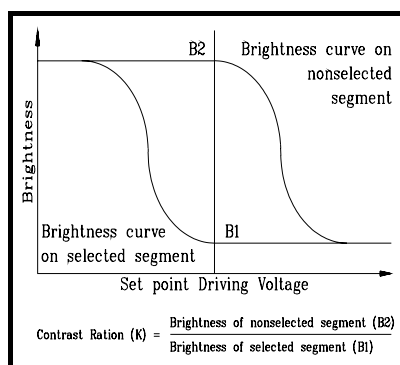
ITEM	SYM	CONDITION	MIN.	TYPE	MAX.	UNIT
VIEW ANGLE (V)	θ	CR \geq 2	-10	--	40	deg.
VIEW ANGLE (H)	φ	CR \geq 2	-30	--	30	deg.
CONTRAST RATIO	CR	--	--	5	--	--
RESPONSE TIME	TON	--	--	180	230	mS
RESPONSE TIME	TOFF	--	--	100	150	mS

7. Optical Definitions

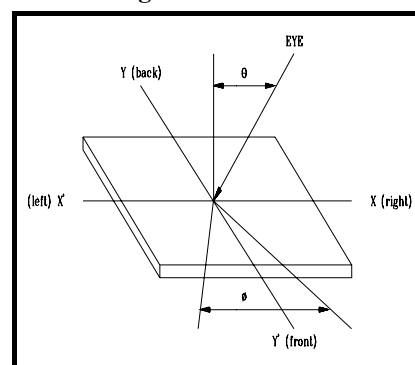
Response Time



Contrast Ration



View Angle



8. Display Address

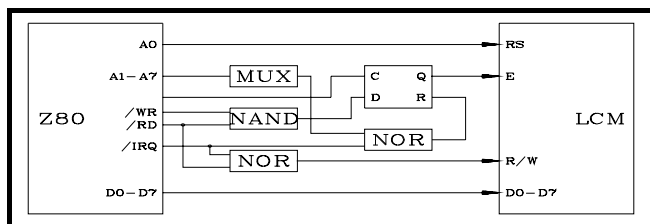
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
Line 1	80H		81H		82H		83H		84H		85H		86H		87H	
Line 2	90H		91H		92H		93H		94H		95H		96H		97H	
Line 3	88H		89H		8AH		8BH		8CH		8DH		8EH		8FH	
Line 4	98H		99H		9AH		9BH		9CH		9DH		9EH		9FH	

	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32
Line 1																
Line 2																
Line 3																
Line 4																

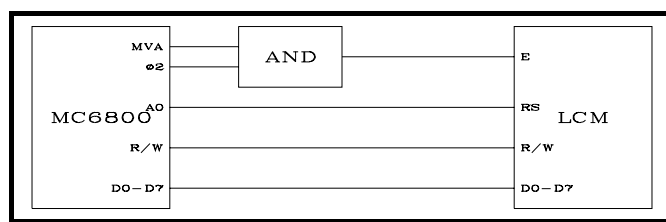
*A Ram Bank is 16 bits (2 bytes)

9. Interface to MPU

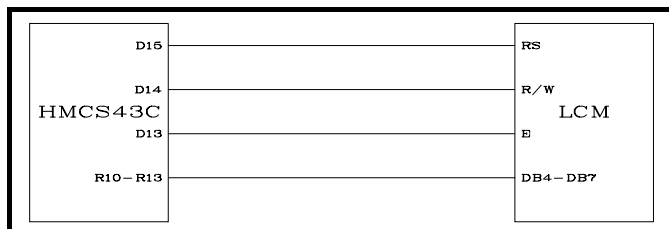
9.1 Interface to Z-80 CPU



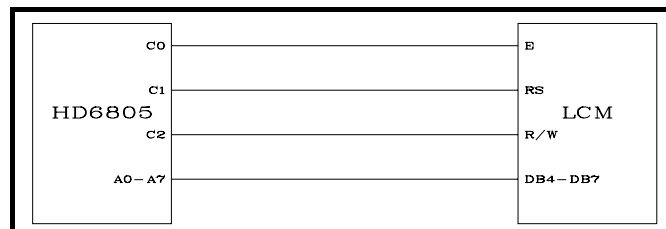
9.2 Interface to MC6800 CPU



9.3 Interface to 4-bit CPU (HMCS43C)



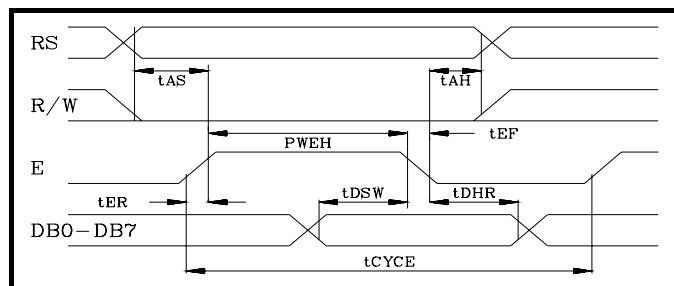
9.4 Interface to HD6805 MP



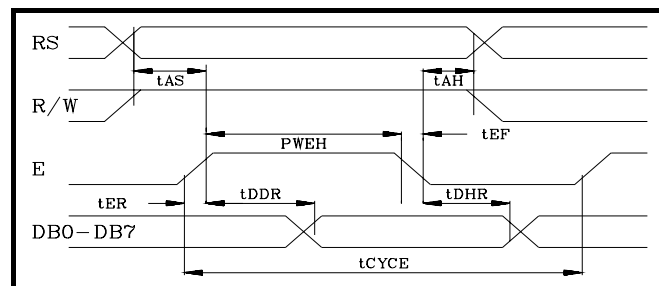
10. Timing Control

10.1 Write and Read Operation

Write Operation

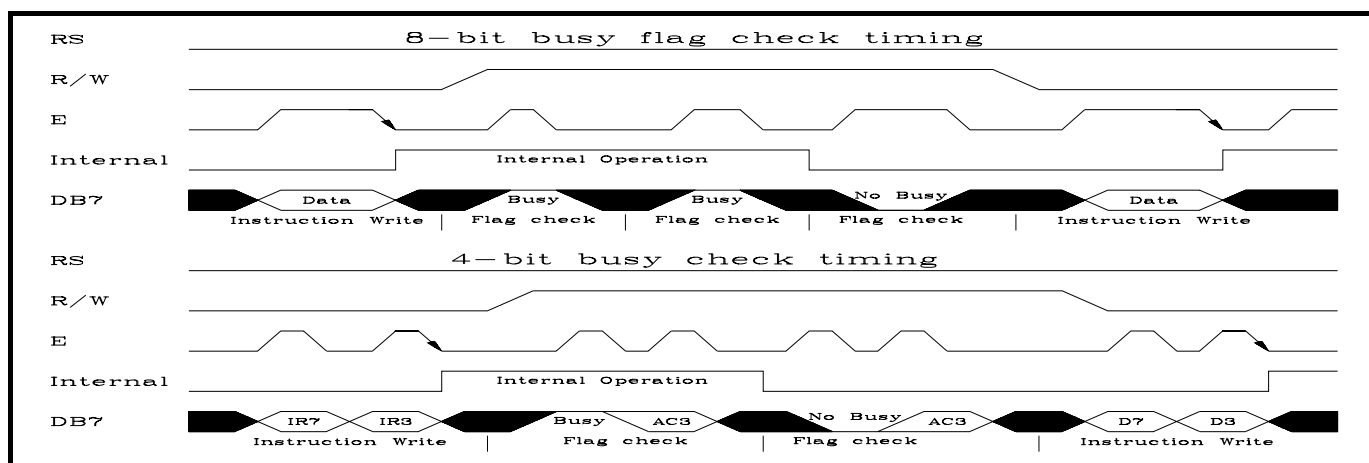


Read Operation



Item	Symbol	Limit (Min.)	Limit (Max.)	Unit
Enable Cycle Time	tCYCE	1200	--	ns
Enable Pules Width (High level)	PWEH	140	--	ns
Enable Rise/Fall Time	tER,tEF	--	25	ns
Address Set-Up Time (RS,R/W,E)	tAS	10	--	ns
Address Hole Time	tAH	20	--	ns
Data Set-Up Time	tDSW	40	--	ns
Data Delay Time	tDDR	--	100	ns
Data Hold Time	tDHR	20	--	ns

10.2 Busy flag check timing

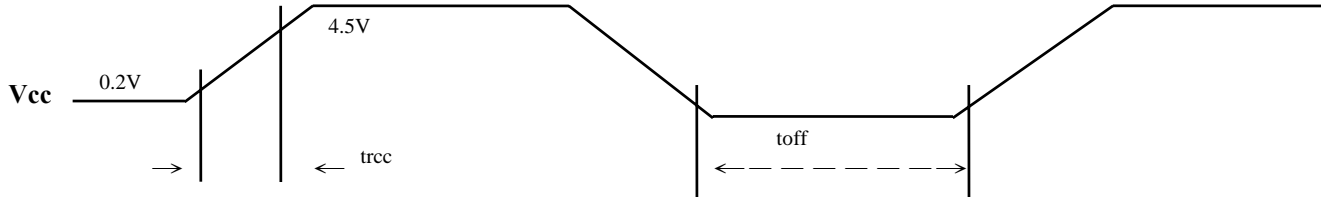


Note : IR7, IR3 : Instruction 7th bit , 3rd bit ; AC3 : Address Counter 3rd bit.

11. Initialization of LCM

The LCM automatically initializes (reset) when power is turned on using the internal reset circuit. If the power supply conditions for correctly operating of the internal reset circuit are not met, initialization by instruction is required. Use the procedure is next page for initialization.

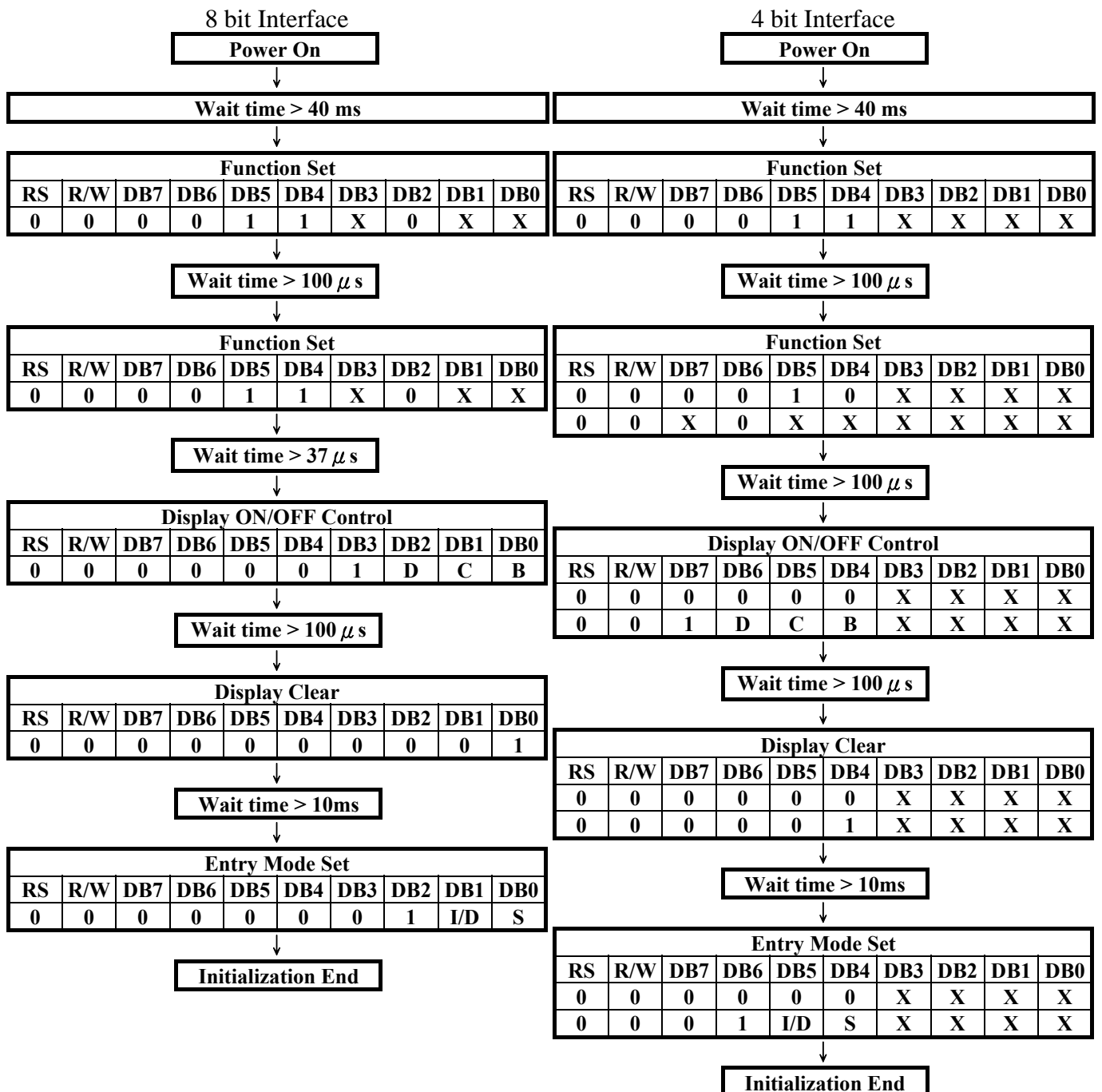
Internal Power Supply reset



(Note 1) $10\text{ ms} \geq tr_{cc} \geq 0.1\text{ ms}$, $to_{ff} \geq 1\text{ ms}$.

(Note 2) to_{ff} stipulates the time of power OFF for momentary power supply dip or when power supply cycles ON and OFF.

Item	Symbol	Test condition	Limit (Min.)	Limit (Max.)	Unit
Power supply rise time	tr_{cc}	--	0.1	10	ms
Power supply off time	to_{ff}	--	1	--	ms



12. Instruction Set

Instruction Table: (RE=0: Enable basic instruction.)

Instruction	Instruction Code										Description	Ex. Time 540KHz
	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
Clear Display	0	0	0	0	0	0	0	0	0	1	Clear entire display and return the cursor to home position (address 0).	4.6ms
Return Home	0	0	0	0	0	0	0	0	1	X	Return cursor to the home position. Also returns the display being shifted to the original position. DDRAM contents remain unchanged.	4.6ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Sets cursor move direction and specifies display shift. These operation are performed during data rite/read. For normal operation. I/D=1 : increment ; 0 :decrement ; S=1 : accompanies display shift when data is written, for normal operation, set to zero.	72 μ s
Display ON/OFF control	0	0	0	0	0	0	1	D	C	B	D=1: ON display ; 0:OFF display. C=1: ON cursor ; 0: OFF cursor. B=1: ON blink cursor ; 0: OFF blink cursor.	72 μ s
Cursor or Display shift	0	0	0	0	0	1	S/C	R/L	X	X	S/C=1: Display shift; 0:Cursor move. R/L=1: shift to right; 0: shift to left.	72 μ s
Function Set (Modify)	0	0	0	0	1	DL	X	0	X	X	DL=1: Interface is 8 bits. 0: Interface is 4 bits. RE=0: Normal instruction .1: Extended instruction.	72 μ s
Set CGRAM address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	72 μ s
Set DDRAM address	0	0	1	0	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter.	72 μ s
Read Busy flag and address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 μ s
Write data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM. (DDRAM/CGRAM/IRAM/GRAM)	72 μ s
Read data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM. (DDRAM/CGRAM/IRAM/GRAM)	72 μ s

Instruction Table (RE=1: Enable extension instruction.)

Instruction	Instruction Code										Description	Ex. Time 540KHz
	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
Standby Mode	0	0	0	0	0	0	0	0	0	1	Enter standby mode, only Icon areas display Standby mode can be released by any other instructions.	72 μ s
Start Row Enable	0	0	0	0	0	0	0	0	1	SR	SR=1: Allow change start display Row. SR=0: Disable start display Row change.	72 μ s
Reverse Line select	0	0	0	0	0	0	0	1	R1	R0	Choice one of 4 line which data is reverse display.	72 μ s
Sleep mode and set GRAM page	0	0	0	0	0	0	1	SL	X	X	SL=0:Enter sleep mode. 1:Wake-up from sleep mode	72 μ s
Function Set (Modify)	0	0	0	0	1	DL	X	1	G	0	DL=1: Interface is 8 bits. 0: Interface is 4 bits. RE=1: Extended instruction.0: Normal instruction. G=1: Graphic display ON. 0: Graphic display OFF	72 μ s
Set Iram/Start Row address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	SR=1: AC5 – AC0 is start Row. SR=0: AC3 – AC0 is ICON RAM address.	72 μ s
Set Graphic RAM address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set GDRAM address in address counter. Execute once set the address of display row (AC6-AC0). Execute again set the address of display column (AC3-AC0).	72 μ s

13. User Font Patterns (CG RAM Character)

Character Code (DDRAM data)					CGRAM Address						CGRAM data (High byte)								CGRAM data (Low byte)											
B15 – B4	B3	B2	B1	B0	B5	B4	B3	B2	B1	B0	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0				
0	X	00	X	00	0	0	0	0	0	0	0	1	0	0	0	0	0	0	1	0	0	1	0	0	0	0	0			
					0	0	0	1	0	1	0	0	0	0	0	0	1	0	0	0	1	0	0	1	0	0	0	0	0	
					0	0	1	0	1	1	1	1	0	0	0	0	1	0	0	0	1	0	0	0	1	0	0	0	0	
					0	0	1	1	0	1	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	0	
					0	1	0	0	0	0	1	0	0	0	1	0	0	0	1	0	0	1	0	0	0	1	0	0	0	
					0	1	0	1	0	1	0	1	0	0	0	1	0	0	0	1	0	0	0	0	0	1	0	0	0	
					0	1	1	0	0	0	1	0	1	0	0	1	0	0	0	1	1	1	1	1	1	1	1	1	1	0
					0	1	1	1	1	1	0	0	1	0	0	1	0	0	0	1	0	0	0	0	1	0	0	0	0	
					1	0	0	0	0	1	0	1	0	0	0	1	0	1	0	0	0	1	0	0	0	0	1	0	0	0
					1	0	0	1	0	0	1	0	0	0	0	1	0	1	0	0	0	1	1	1	1	1	1	1	1	0
					1	0	1	0	0	0	0	1	0	0	0	0	0	1	0	0	0	1	0	0	0	0	1	0	0	0
					1	0	1	1	0	0	1	0	0	0	1	0	0	0	1	0	0	1	0	0	0	0	1	0	0	0
					1	1	0	0	0	1	1	1	1	1	1	1	1	1	0	0	0	1	1	1	1	1	1	1	1	0
					1	1	0	1	0	0	0	0	1	0	0	1	0	0	0	1	0	0	1	0	0	0	0	0	0	0
					1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
					0	X	01	X	01	0	0	0	0	0	0	0	0	1	0	0	0	0	0	1	1	1	1	1	1	1
0	0	0	1	0						0	1	0	0	0	0	0	1	0	1	0	1	0	1	0	1	0	1	0	0	
0	0	1	0	0						1	0	1	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	0	0	
0	0	1	1	1						1	1	1	1	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	
0	1	0	0	0						1	0	1	0	1	0	0	0	1	0	0	0	1	1	1	1	1	1	0	0	0
0	1	0	1	0						0	1	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
0	1	1	0	0						0	0	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0
0	1	1	1	1						1	1	1	1	1	0	0	0	0	1	0	0	0	1	0	0	0	0	0	0	
1	0	0	0	0						0	0	1	0	0	0	0	0	0	0	0	0	1	0	1	0	1	0	0	0	0
1	0	0	1	0						0	0	1	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0
1	0	1	0	0						0	0	1	0	1	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0
1	0	1	1	0						0	1	0	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0
1	1	0	0	0						1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0
1	1	0	1	0						0	0	1	1	1	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0
1	1	1	0	1						0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

14. Icon RAM Data

Icon RAM Address				Icon RAM Data															
				High Byte								Low Byte							
AC3	AC2	AC1	AC0	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	Seg0	Seg1	Seg2	Seg3	Seg4	Seg5	Seg6	Seg7	Seg8	Seg9	Seg10	Seg11	Seg12	Seg13	Seg14	Seg15
0	0	0	1	Seg16	Seg17	Seg18	Seg19	Seg20	Seg21	Seg22	Seg23	Seg24	Seg25	Seg26	Seg27	Seg28	Seg29	Seg30	Seg31
0	0	1	0	Seg32	Seg33	Seg34	Seg35	Seg36	Seg37	Seg38	Seg39	Seg40	Seg41	Seg42	Seg43	Seg44	Seg45	Seg46	Seg47
0	0	1	1	Seg48	Seg49	Seg50	Seg51	Seg52	Seg53	Seg54	Seg55	Seg56	Seg57	Seg58	Seg59	Seg60	Seg61	Seg62	Seg63
0	1	0	0	Seg64	Seg65	Seg66	Seg67	Seg68	Seg69	Seg70	Seg71	Seg72	Seg73	Seg74	Seg75	Seg76	Seg77	Seg78	Seg79
0	1	0	1	Seg80	Seg81	Seg82	Seg83	Seg84	Seg85	Seg86	Seg87	Seg88	Seg89	Seg90	Seg91	Seg92	Seg93	Seg94	Seg95
0	1	1	0	Seg96	Seg97	Seg98	Seg99	Seg100	Seg101	Seg102	Seg103	Seg104	Seg105	Seg106	Seg107	Seg108	Seg109	Seg110	Seg111
0	1	1	1	Seg112	Seg113	Seg114	Seg115	Seg116	Seg117	Seg118	Seg119	Seg120	Seg121	Seg122	Seg123	Seg124	Seg125	Seg126	Seg127
1	0	0	0	Seg128	Seg129	Seg130	Seg131	Seg132	Seg133	Seg134	Seg135	Seg136	Seg137	Seg138	Seg139	Seg140	Seg141	Seg142	Seg143
1	0	0	1	Seg144	Seg145	Seg146	Seg147	Seg148	Seg149	Seg150	Seg151	Seg152	Seg153	Seg154	Seg155	Seg156	Seg157	Seg158	Seg159
1	0	1	0	Seg160	Seg161	Seg162	Seg163	Seg164	Seg165	Seg166	Seg167	Seg168	Seg169	Seg170	Seg171	Seg172	Seg173	Seg174	Seg175
1	0	1	1	Seg176	Seg177	Seg178	Seg179	Seg180	Seg181	Seg182	Seg183	Seg184	Seg185	Seg186	Seg187	Seg188	Seg189	Seg190	Seg191
1	1	0	0	Seg192	Seg193	Seg194	Seg195	Seg196	Seg197	Seg198	Seg199	Seg200	Seg201	Seg202	Seg203	Seg204	Seg205	Seg206	Seg207
1	1	0	1	Seg208	Seg209	Seg210	Seg211	Seg212	Seg213	Seg214	Seg215	Seg216	Seg217	Seg218	Seg219	Seg220	Seg221	Seg222	Seg223
1	1	1	0	Seg224	Seg225	Seg226	Seg227	Seg228	Seg229	Seg230	Seg231	Seg232	Seg233	Seg234	Seg235	Seg236	Seg237	Seg238	Seg239
1	1	1	1	Seg240	Seg241	Seg242	Seg243	Seg244	Seg245	Seg246	Seg247	Seg248	Seg249	Seg250	Seg251	Seg252	Seg253	Seg254	Seg255

15. Graph Display RAM Address

GDRAM Column Address	GDRAM Row Address			
	0	1	-----	15
0	D15 → D0	D15 → D0	D15 → D0	D15 → D0
1	D15 → D0	D15 → D0	D15 → D0	D15 → D0
2	D15 → D0	D15 → D0	D15 → D0	D15 → D0
:	:	:	:	:
61	D15 → D0	D15 → D0	D15 → D0	D15 → D0
62	D15 → D0	D15 → D0	D15 → D0	D15 → D0
63	D15 → D0	D15 → D0	D15 → D0	D15 → D0

16. Software Example

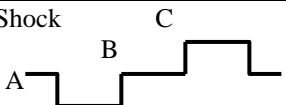
16.1 8-bit operation (8 bits 2 lines)

Function	R S	R W	D 7	D 6	D 5	D 4	D 3	D 2	D 1	D 0	Display	Description
Power on delay												Initialization. No display appears.
Function set	0	0	0	0	1	1	0	0	0	0		Sets to 8-bit operation and selects 2-line display character font. (Note: number of display lines and character fonts cannot be change after this.)
Display OFF	0	0	0	0	0	0	1	0	0	0		Turn off display.
Display ON	0	0	0	0	0	0	1	1	1	0	—	Turn on display and cursor
Entry Mode Set	0	0	0	0	0	0	0	1	1	0	—	Set mode to increment the address by one and to shift the cursor to the right, at the time of write, to the DD/CG RAM Display is not shifted.
Write data to CG/DD RAM	1	0	1	0	1	1	0	1	1	0	雄	Write “雄”. Cursor incremented by one and shift to right.
Write data to CG/DD RAM	1	0	1	1	0	0	0	1	0	1	雄鐸	Write “鐸” .
Set DD RAM	0	0	1	0	0	1	0	0	0	0	雄鐸	Set RAM address so that the cursor is propositioned at the head of the second line.
Write data to CG/DD RAM			*		*						雄鐸 CR	Write “C” , and “R”.
Cursor or display shift	0	0	0	0	0	1	0	0	x	x	雄鐸 CR	Shift only the cursor position to the left.
Write data to CG/DD RAM			*		*						雄鐸 CO., LTD.	Write “O., LTD.” .
Entry Mode Set	0	0	0	0	0	0	0	1	1	1	雄鐸 CO., LTD.	Set display mode shift at the time during writing operation.
Write data to CG/DD RAM	1	0	0	1	1	1	1	0	0	0	鐸 ., LTD. x	Write “ x”. Cursor incremented by one and shift to right. (The display move to left.)
Write data to CG/DD RAM			*		*							Write other characters.
Return Home	0	0	0	0	0	0	0	0	1	0	雄鐸 CO., LTD.	Return both display and cursor to the original position (Set address to zero).

16.2 4-bit operation (4-bit, 1 line)

Function	RS	R/ W	D7	D6	D5	D4	Display	Description
power on delay								initialization. No display appears.
Function set	0	0	0	0	1	0		Sets to 4-bit operation. In this case, operation is handled as 8-bits by initialization, and only this instruction completes with one write.
Function set	0	0	0	0	0	0		Sets 4-bit operation and selects 1-line display character font on and resetting is needed. (number of display lines and character fonts cannot be changed hence after).
Display ON/OFF Control	0	0	0	0	0	0	—	Turn on display and cursor.
Entry Mode Set	0	0	0	0	0	0	—	Set mode to incremented the address by one and to shift the cursor to the right, at the time of write. to the DD/CG RAM display is not shifted.
Write data to CG/DD RAM	1	0	1	0	1	1	雄	Write “雄”. Cursor incremented by one and shift to right.
	1	0	0	1	1	0		
	1	0	1	0	1	0		
	1	0	1	1	1	1		
same as 8-bit operation								

17. Reliability Condition

		TN Type		STN Type		
		Normal Temp.	Wide Temp.	Normal Temp.	Wide Temp.	
Viewing Angle	Horizontal Φ	$\pm 30^{\circ}$	$\pm 30^{\circ}$	$\pm 30^{\circ}$	$\pm 30^{\circ}$	
	Vertical Θ (mm)	-10° to 30°	-10° to 30°	-10° to 40°	-10° to 40°	
Operating Temperature		-10 to 70℃	-25 to 80℃	0 to 50℃	*-20 to 70℃	
Storage Temperature		-20 to 80℃	-35 to 90℃	-20 to 70℃	*-30 to 80℃	
High Temperature (Power Off)		240 Hours @70℃	240 Hours @90℃	240 Hours @65℃	240 Hours @75℃	
Low Temperature (Power Off)		240 Hours @-20℃	240 Hours @-35℃	240 Hours @-15℃	240 Hours @-25℃	
High Temperature (Power On)		240 Hours @70℃	240 Hours @80℃	240 Hours @60℃	240 Hours @70℃	
Low Temperature (Power On)		240 Hours @-10℃	240 Hours @-25℃	240 Hours @-10℃	240 Hours @-20℃	
High Temperature & High Humidity		55℃/90%RH 240 Hours	75℃/90%RH 240 Hours	45℃/90%RH 240 Hours	65℃/90%RH 240 Hours	
Thermal Shock 5 Cycle		A	60min@-20℃	60min@-35℃	60min@-20℃	
		B	5min@25℃	5min@25℃	5min@25℃	5min@25℃
		C	60min@70℃	60min@90℃	60min@70℃	60min@80℃
Expected Lift		50,000 Hours	50,000 Hours	50,000 Hours	50,000 Hours	

*Wide temp. version may not available for some products, Please consult our sales engineer or representative.

18. Functional Test & Inspection Criteria

18.1 Sample plan

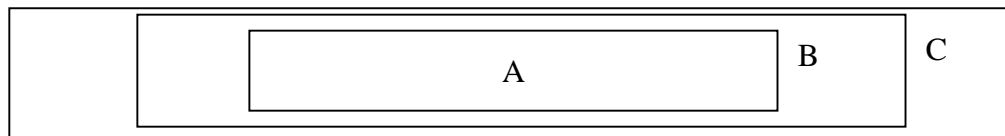
Sample plan according to MIL-STD-105D level 2, and acceptance/rejection criteria is.

Base on : Major defect : AQL 0.65 Minor defect : AQL 2.5

18.2 Inspection condition

Viewing distance for cosmetic inspection is 30cm with bare eyes, and under an environment of 800 lus (20W) light intensity. All direction for inspecting the sample should be within 45° against perpendicular line.

18.3 Definition of Inspection Zone in LCD



Zone A : Character / Digit area

Zone B : Viewing area except Zone A (Zone A + Zone B = minimum Viewing area)

Zone C : Outside viewing area (invisible area after assembly in customer's product)

Note : As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

18.4 Major Defect

All functional defects such as open (or missing segment), short, contrast differential, excess power consumption, smearing, leakage, etc. and overall outline dimension beyond the drawing. Are classified as major defects.

18.5 Minor Defect

Except the Major defects above, all cosmetic defects are classified as minor defects.

Item No.	Item to be Inspected	Inspection Standard					Classification of defects
1.	Spot defect (Defects in spot from)	Zone size (mm)	Acceptable Qty			Minor	
			A	B	C		
		$\Phi \leq 0.15$	Acceptable (clutering of spot not allowed)		Accepta- ble		
		$0.15 \leq \Phi \leq 0.20$	1	2			
		$0.20 \leq \Phi \leq 0.25$	0	1			
		$\Phi > 0.25$	0	0			
Remarks : for dark/white spot, size Φ is defined as $\Phi = 1/2(X+Y)$							
2.	Line defect (Defects in line form)	Size (mm)		Acceptable Qty			Minor
		L Length	W Width	Zone			
				A	B	C	
		Accep- table	$W \leq 0.02$	Accep- table	Accept- table		
		$L \leq 3.0$	$W \leq 0.03$	2			
		$L > 2.5$	$W \leq 0.03$	0			
		$L \leq 3.0$	$0.03 < W \leq 0.05$	2			
		$L > 2.5$	$0.03 < W \leq 0.05$	0			
			$W > 0.05$	Counted as spot defect (Follows item 18.5.1)			
Remarks: The total of spot defect and line defect shall not exceed four.							
3.	Orientation defect (such as misalignment of L/C)	Not allowed inside viewing area (Zone A or Zone B)					Minor
4.	Polarizing	18.5.4.1 Polarizer Position					Minor
		1. Shifting in Position Should not exceed the glass outline dimension.					
		2. Incomplete covering of the viewing area due to Shifting is not allowed.					
		18.5.4.2 Seratches, bubble or dent on Glass/ Polarizer/Reflector, Bubble between Polarizer & Reflector/Glass:					
		Size (mm)	Acceptable Qty			Accept- table	
			Zone				
			A	B	C		
		$\Phi \leq 0.20$	Acceptable				
		$0.20 < \Phi \leq 0.50$	3				
$0.50 < \Phi \leq 1.00$	2						
$\Phi > 1.00$	0						

19. Character Generator ROM Map

High 4-bit	Low 4-bit															
	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0			☹	♥	♦	♣	♠	•	•	○	○	♂	♀	♪	♪	☀
1	▶	◀	↑	!!	¶	§	■	↑	↑	↓	→	←	⊥	↔	▲	▼
2		!	“	#	\$	%	&	‘	()	*	+	,	—	•	/
3	0	1	2	3	4	5	6	7	8	9	:	;	<	=	>	?
4	@	A	B	C	D	E	F	G	H	I	J	K	L	M	N	O
5	P	Q	R	S	T	U	V	W	X	Y	Z	[\]	^	_
6	‘	a	b	c	d	e	f	g	h	i	j	k	l	m	n	o
7	p	q	r	s	t	u	v	w	x	y	z	{		}	~	△

字型碼，前 127 碼為標準 ASCII 碼，在中文為半形，中文碼由 A140 開始，共 8192 字，編碼方式為 BIG-5 碼。